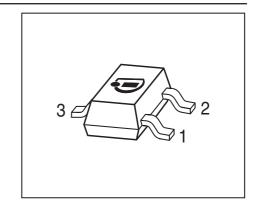


PNP Silicon AF Transistors

- For general AF applications
- High current gain
- Low collector-emitter saturation voltage
- Complementary types: BCW66... (NPN)
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101







Туре	Marking	Pin Configuration			Package
BCW67A	DAs	1=B	2=E	3=C	SOT23
BCW67B	DBs	1=B	2=E	3=C	SOT23
BCW67C	DCs	1=B	2=E	3=C	SOT23
BCW68F	DFs	1=B	2=E	3=C	SOT23
BCW68G	DGs	1=B	2=E	3=C	SOT23
BCW68H	DHs	1=B	2=E	3=C	SOT23

1

K/W

≤ 215



Maximum Ratings

Junction - soldering point¹⁾

Parameter	Symbol	Value	Unit
Collector-emitter voltage	$V_{\sf CEO}$		V
BCW67		32	
BCW68		45	
Collector-base voltage	V _{CBO}		
BCW67		45	
BCW68		60	
Emitter-base voltage	V _{EBO}	5	
Collector current	I _C	800	mA
Peak collector current, $t_p \le 10 \text{ ms}$	I _{CM}	1	А
Base current	l _B	100	mA
Peak base current	I _{BM}	200	
Total power dissipation, <i>T</i> _S ≤ 79°C	P _{tot}	330	mW
Junction temperature	$T_{\rm j}$	150	°C
Storage temperature	T _{stg}	-65 150	
Thermal Resistance			
Parameter	Symbol	Value	Unit

R_{thJS}

 $^{^{1}}$ For calculation of R_{thJA} please refer to Application Note AN077 (Thermal Resistance Calculation)



Electrical Characteristics at $T_A = 25^{\circ}$ C, unless otherwise specified Symbol **Values** Unit **Parameter** min. typ. max. **DC Characteristics** ٧ $V_{(BR)CEO}$ Collector-emitter breakdown voltage $I_{\rm C} = 10 \text{ mA}, I_{\rm B} = 0 \text{ , BCW67}$ 32 $I_{\rm C}$ = 10 mA, $I_{\rm B}$ = 0 , BCW68 45 Collector-base breakdown voltage $V_{(BR)CBO}$ $I_{\rm C} = 10 \, \mu \text{A}, I_{\rm F} = 0 \, \text{, BCW67}$ 45 $I_{\rm C} = 10 \, \mu \text{A}, I_{\rm F} = 0 \, , \, \text{BCW68}$ 60 Emitter-base breakdown voltage 5 $V_{(BR)EBO}$ $I_{\rm F} = 10 \, \mu A, I_{\rm C} = 0$ Collector-base cutoff current μΑ $I_{\rm CBO}$ $V_{\rm CB} = 32 \text{ V}, I_{\rm F} = 0$ 0.02 $V_{\rm CB} = 45 \, \rm V, I_{\rm F} = 0$ 0.02 $V_{CB} = 32 \text{ V}, I_{E} = 0, T_{A} = 150 \text{ °C; BCW67}$ 20 $V_{\rm CB}$ = 45 V, $I_{\rm F}$ = 0 , $T_{\rm A}$ = 150 °C; BCW68 20 20 nΑ Emitter-base cutoff current *I*EBO $V_{\rm EB} = 4 \text{ V}, I_{\rm C} = 0$ DC current gain¹⁾ h_{FE} $I_{\rm C}$ = 100 μ A, $V_{\rm CF}$ = 10 V, $h_{\rm FF}$ -grp.A/F 35 $I_{\rm C}$ = 100 μ A, $V_{\rm CF}$ = 10 V, $h_{\rm FF}$ -grp.B/G 50 $I_{\rm C}$ = 100 μ A, $V_{\rm CF}$ = 10 V, $h_{\rm FF}$ -grp.C/H 80 $I_{\rm C}$ = 10 mA, $V_{\rm CF}$ = 1 V, $h_{\rm FF}$ -grp.A/F 75 $I_{\rm C}$ = 10 mA, $V_{\rm CF}$ = 1 V, $h_{\rm FF}$ -grp.B/G 120 $I_{\rm C}$ = 10 mA, $V_{\rm CF}$ = 1 V, $h_{\rm FF}$ -grp.C/H 180 $I_{\rm C}$ = 100 mA, $V_{\rm CE}$ = 1 V, $h_{\rm FE}$ -grp.A/F 100 160 250 $I_{\rm C}$ = 100 mA, $V_{\rm CF}$ = 1 V, $h_{\rm FF}$ -grp.B/G 400 160 250 $I_{\rm C}$ = 100 mA, $V_{\rm CF}$ = 1 V, $h_{\rm FF}$ -grp.C/H 350 630 250 $I_{\rm C}$ = 500 mA, $V_{\rm CF}$ = 2 V, $h_{\rm FF}$ -grp.A/F 35 $I_{\rm C}$ = 500 mA, $V_{\rm CF}$ = 2 V, $h_{\rm FF}$ -grp.B/G 60 $I_{\rm C}$ = 500 mA, $V_{\rm CF}$ = 2 V, $h_{\rm FF}$ -grp.C/H 100



DC Electrical Characteristics

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Characteristics	,				
Collector-emitter saturation voltage ¹⁾	V _{CEsat}				V
$I_{\rm C}$ = 100 mA, $I_{\rm B}$ = 10 mA		-	-	0.3	
$I_{\rm C}$ = 500 mA, $I_{\rm B}$ = 50 mA		-	-	0.7	
Base emitter saturation voltage ¹⁾	V _{BEsat}				
$I_{\rm C}$ = 100 mA, $I_{\rm B}$ = 10 mA		-	-	1.25	
$I_{\rm C}$ = 500 mA, $I_{\rm B}$ = 50 mA		-	-	2	
AC Characteristics	·	•			<u>. </u>
Transition frequency	f_{T}	-	200	-	MHz
$I_{\rm C}$ = 50 mA, $V_{\rm CE}$ = 5 V, f = 20 MHz					
Collector-base capacitance	C _{cb}	-	6	-	pF
$V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}$					
Emitter-base capacitance	C _{eb}	-	60	-	
$V_{\rm EB}$ = 0.5 V, f = 1 MHz					

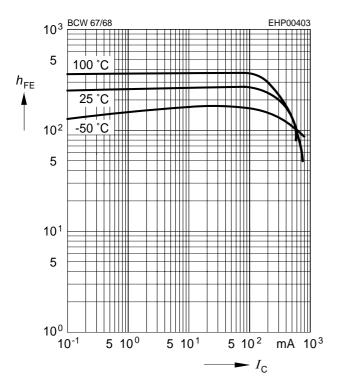
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¹Pulse test: $t < 300\mu s$; D < 2%



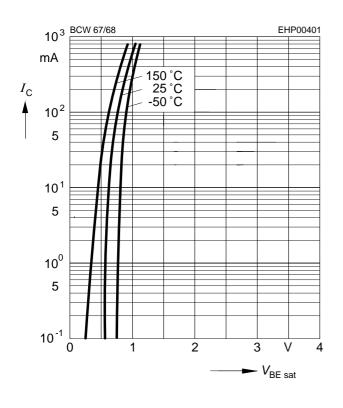
DC current gain $h_{FE} = f(I_C)$

$$V_{CE} = 1 \text{ V}$$



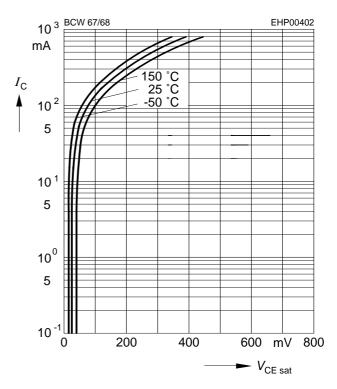
Base-emitter saturation voltage

$$I_{\text{C}} = f(V_{\text{BEsat}}), h_{\text{FE}} = 10$$



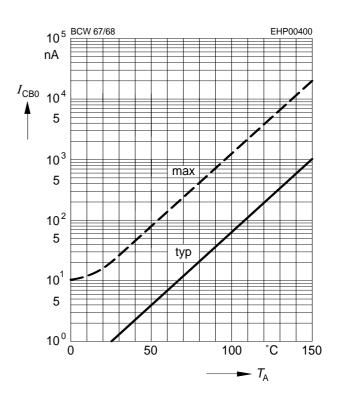
Collector-emitter saturation voltage

$$I_{\text{C}} = f(V_{\text{CEsat}}), h_{\text{FE}} = 10$$



Collector cutoff current $I_{CBO} = f(T_A)$

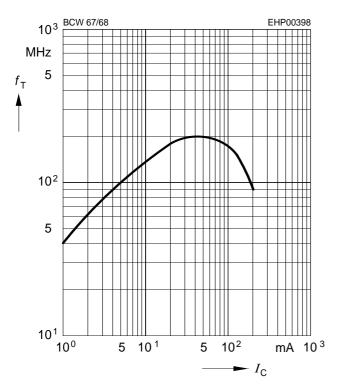
$$V_{\rm CBO}$$
 = 25 V



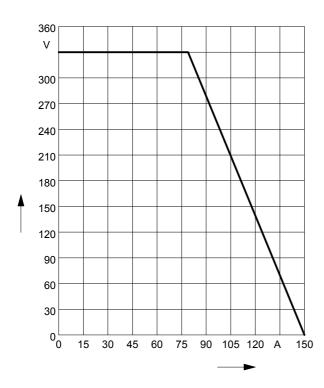


Transition frequency $f_T = f(I_C)$

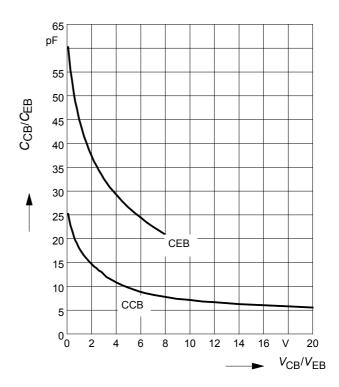
 V_{CE} = 5 V



Total power dissipation $P_{\text{tot}} = f(T_{\text{S}})$

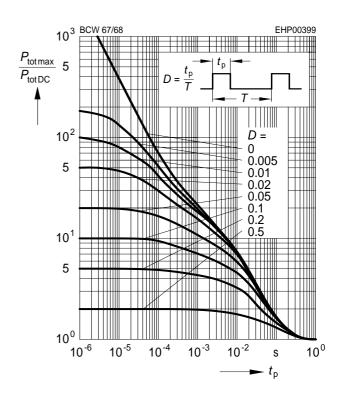


Collector-base capacitance $C_{cb} = f(V_{CB})$ Emitter-base capacitance $C_{eb} = f(V_{EB})$



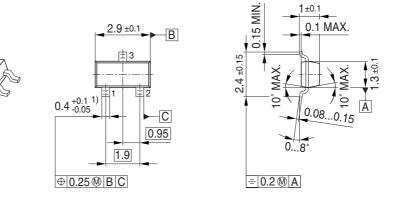
Permissible Pulse Load

 $P_{\text{totmax}}/P_{\text{totDC}} = f(t_{\text{p}})$



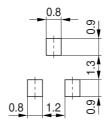


Package Outline

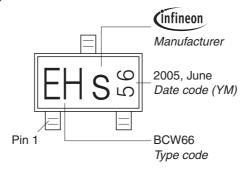


1) Lead width can be 0.6 max. in dambar area

Foot Print

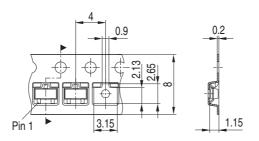


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel





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